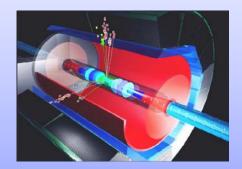


# **DESY Summary**

<u>Ingrid-Maria Gregor</u>, Julia Fourletova, Tobias Haas Tatsiana Klimkovich, Ulrich Koetz Alessandro Montanari, Carsten Muhl, Jolanta Sztuk



Chip Characterisation
Integration Planning

JRA1 Meeting in Geneva March 27th 2007



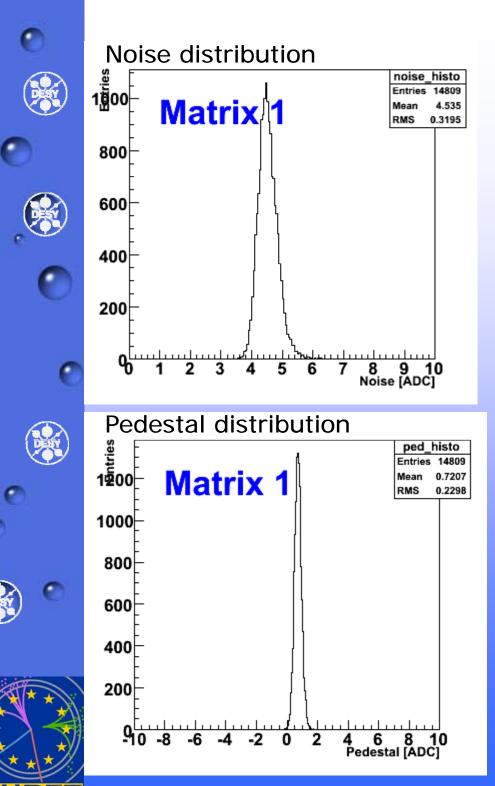


- First bonded MimoTel and Mimosa18 were delivered to DESY
- Along with this we received new versions of Strasbourg DAQ and JTAG programming
- Turning on the MimoTel and Mimosa18 was without any problems
- Preparing a test protocol to have a standardised test procedure for each sensor of one kind
  - > Functionality test (smoke test ;-) )
  - Pedestal and noise
  - > Response to Fe55  $K_{\alpha}$  and  $K_{\beta}$
  - Number of dead/noisy pixel
  - Anything else ?
- Store all information on data base accessible for JRA1 members
  - Results, "features"
  - Iocation

ntrastructure

Ingrid-Maria

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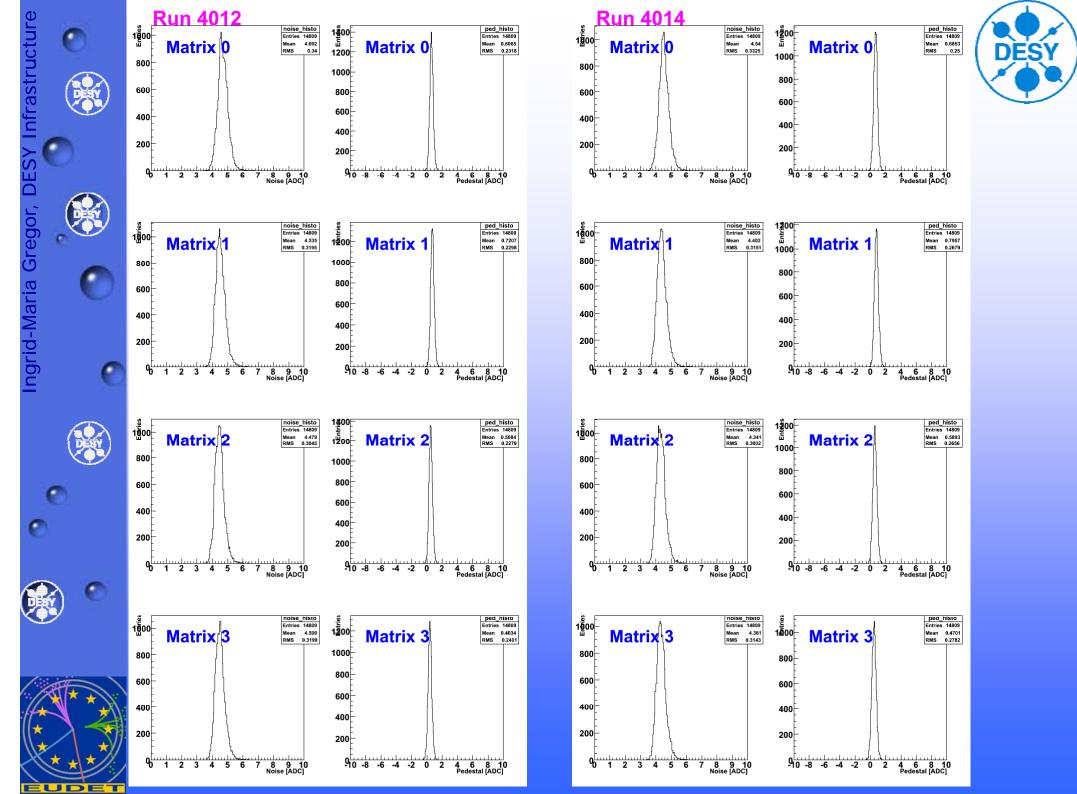


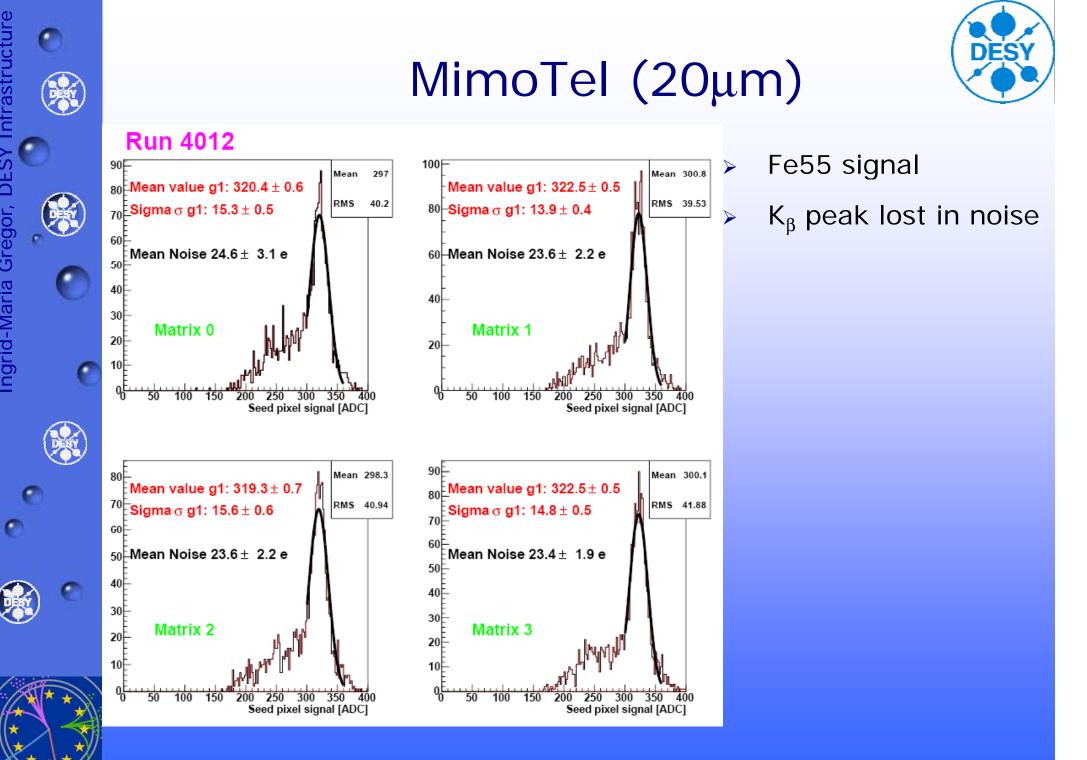
ngrid-Maria

# MimoTel (20µm)



- Example: chip#3 on Strasbourg sensor board
- > Data taken at 10MHz
- Noise: ~4.5ADC -> 25 e-
- Wojtek: only 16 e- noise
- Observed rise in noise when taking data -> sensitive to temperature increase
- Textbox is noticeably warm
- Systematic studies will start next week when test box is cooled (and temp. stabilised)





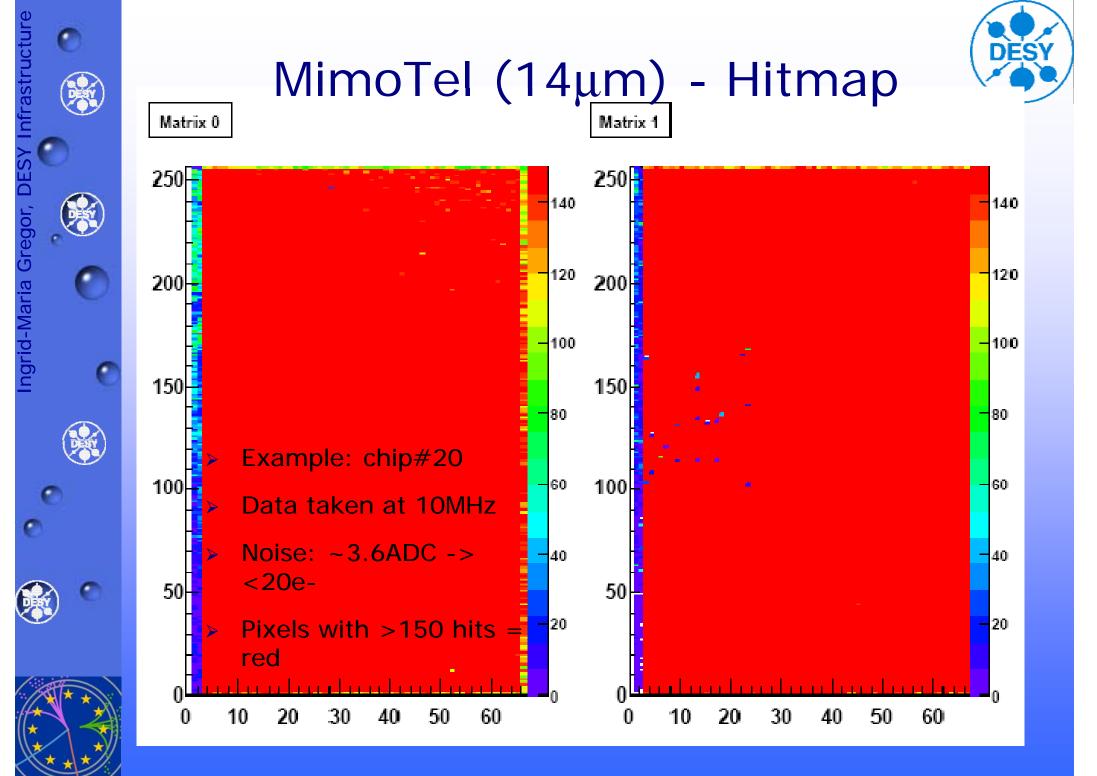


## MimoTel (14µm)



- Connected to exactly the same AUX board with same settings and same file for JTAG programming
- Noise already quite decreased
- Need to study in detail
- Fe55 signal
- >  $K_{\beta}$  visible

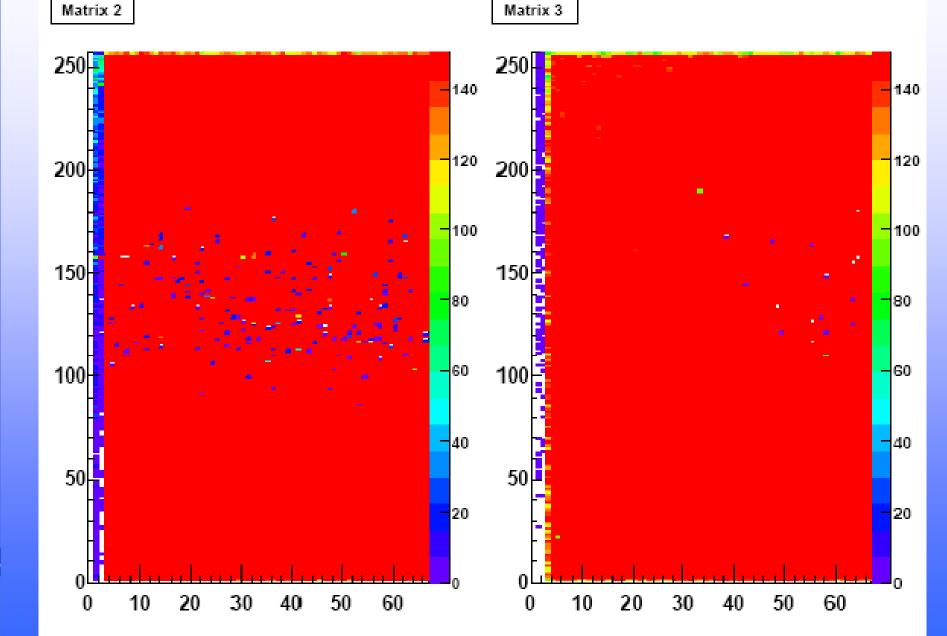






### MimoTel (14µm) - Hitmap

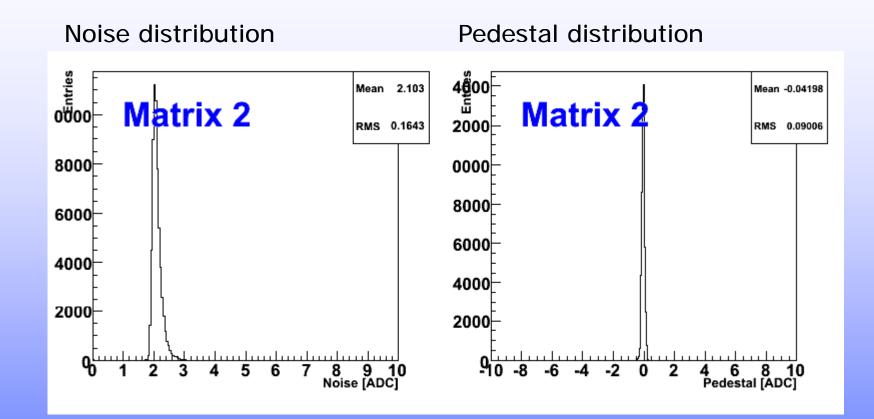






## Mimosa18





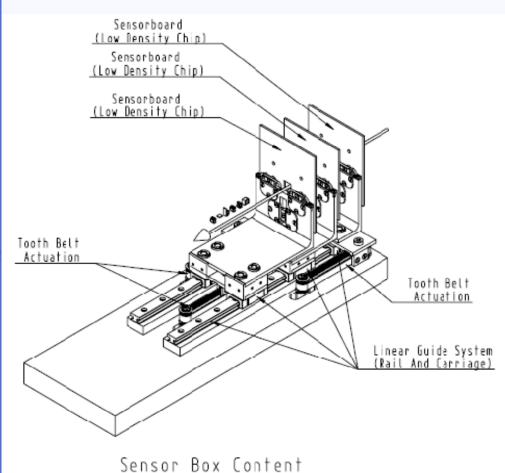
- Test of Mimosa18 was very straight forward
- First noise measurement showed similar results as Wojtek (11e-)





### Senor Boxes





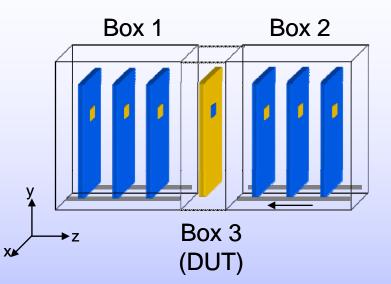
- Mechanics design almost completed
- > 3 planes on one main structure
  - Each has different geometry depending on position
  - Each plane movable individually with small tool
- Minimal distance between planes: 7mm
- Maximum level arm: 200 mm
- > Material: aluminum
  - > All material non-magnetic
  - Materials were optimised for minimal thermal stress

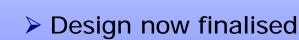


#### Carsten Muhl

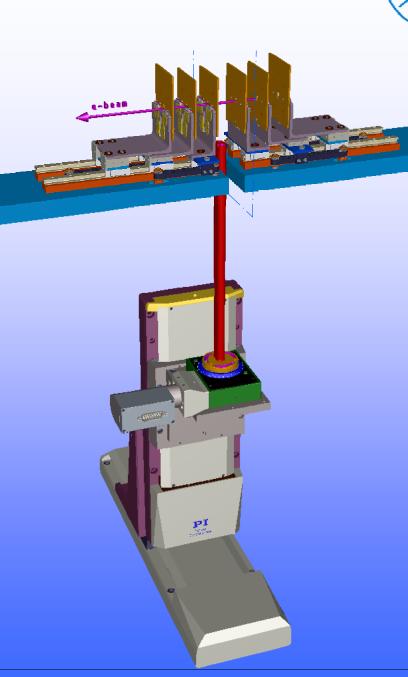
### **Overall Construction**







- Machining will start next week
- Complete system available end of June





nfrastructure

Ingrid-Maria Grego

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#### Carsten Muhl



### **Overall Integration**



- Mechanics completed by end of June
- May/June 2007
  - First test of 2 (or more) chips in testbeam at DESY
  - > Ample of time booked for area 24
  - EUDRB(s) at DESY necessary
- July: complete assembly of mechanics + chips + readout (no test beams available at DESY 2.7-15.8)
- August: first test of complete system in testbeam
- End of September: go to CERN for testbeam





## Summary



- Magnet from Japan delivered and tested up to full field (1.2T)
- XY table delivered and tested on bench top
- Mechanical design of sensor boxes well under way
- Board production delayed but under way

